

SANYO Semiconductors DATA SHEET

LV762XXX Series

For NTSC/PAL/SECAM Color TVs
Built-in CTV Microcontroller
Video and Sound Processing ICs
(VIF/SIF/Y/C/Deflection/CbCr IN)

Overview

The LV762XXX series is a single-chip video and sound processor IC with a built-in microcontroller that supports all of the NTSC, PAL and SECAM broadcasting systems. The IC provides fully integrated solution to rationalize the design of color TV sets, increase productivity, and reduce total costs.

Functions

- I²C bus control system with a built-in microcontroller
- VIF/SIF/Y/C/Deflection/CbCr IN
- Adjustment-free VIF/SIF
- 1X'tal multi-system that supports NTSC, PAL and SECAM broadcasting systems
- No VCO coil required
- Internal sound carrier BPF, 4-system sound carrier trap
- Digital AFT system

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Lineup

Type No.	SECAM	Tone/Surround	E/W	Teletext	ROM
LV762102F					Flash 64K(P:48K,GC:16K)
LV762102C					MASK 64K(P:48K,GC:16K)
LV762113F			0		Flash 128K(P:96K,GC:32K)
LV762113C			0		MASK 128K(P:96K,GC:32K)
LV762133F		0	0		Flash 128K(P:96K,GC:32K)
LV762133C		0	0		MASK 128K(P:96K,GC:32K)
LV762213F	0		0		Flash 128K(P:96K,GC:32K)
LV762213C	0		0		MASK 128K(P:96K,GC:32K)
LV762232F	0	0	0		Flash 64K(P:48K,GC:16K)
LV762232C	0	0	0		MASK 64K(P:48K,GC:16K)
LV762233F	0	0	0		Flash 128K(P:96K,GC:32K)
LV762233C	0	0	0		MASK 128K(P:96K,GC:32K)
LV76233N5F	0	0	0	0	Flash 192K(P:140K,GC:52K)

Specifications

Maximum Ratings (BIP Chip) at Ta = 25°C

Parameter	Symbol	Conditions	Ratings	Unit
Maximum supply voltage	V ₆₂ max		6.0	V
	V ₄ max		6.0	V
Maximum supply current	Ig max		15	mA
	I ₂₀ max		20	mA
	I ₄₉ max		26.5	mA
Allowable power dissipation	Pd max	Ta ≤ 65°C *	1.3	W
Operating temperature	Topr		-10 to +65	°C
Storage temperature	Tstg		-55 to +150	°C

^{*} Mounted on a substrate: 230mm×150mm×1.6mm, glass epoxy board.

Absolute Maximum Ratings (Micro-computer Chip) at $Ta=25^{\circ}C,\,V_{SS}=0V$

Parameter		O. make at	B***	0	Ratings			11.7
		Symbol	Pins	Conditions	min	typ	max	Unit
Maximum supply voltege		V _{DD} max	CpuV _{DD}		-0.3		+6.0	V
Input voltege		VI	XT1, RES		-0.3		V _{DD} +0.3	V
Output voltege		V _O (1)	XT2, FILT		-0.3		V _{DD} +0.3	V
		V _O (2)	CpuV _{DD} 2		-0.3		3.3V+0.3	V
Input/output voltege		V _{IO}	Ports0, 1		-0.3		V _{DD} +0.3	V
High level output current	Peak output current	I _O PH	Ports04 to 07, 1	CMOS output For each pin.	-10			mA
	Mean output current	I _O MH	Ports04 to 07, 1	•CMOS output •For each pin.	-1			mA
	Total output current	ΣΙΟΑΗ	Ports04 to 07, 1	The total of all pins.	-25			mA
Low lever output current	Peak output current	I _O PL	Ports0, 1	For cach pin			20	mA
	Mean output current	I _O ML(1)	P02, P03, P06, P07 Ports1	For cach pin			1	mA
		I _O ML(2)	P00, P01, P04, P05	For cach pin			8	mA
	Toral output current	Σl _O AL(1)	P02, P03, P06, P07 Ports1	The total of all pins.			45	mA
		ΣI _O AL(2)	P00, P01, P04, P05	The total of all pins.			16	mA

Operating Conditions (BIP Chip) at Ta = 25°C

Parameter	Symbol	Conditions	Ratings	Unit
Recommended supply voltage	V ₆₂		5.0	٧
	V ₄		5.0	V
Recommended supply current	lg		11	mA
	l ₂₀		13	mA
	149		22	mA
Operating supply voltage range	V ₆₂		4.7 to 5.3	V
	V ₄		4.7 to 5.3	V
Operating supply current range	lg		9 to 13	mA
	l ₂₀		11 to 15	mA
	149		20.5 to 26.5	mA

Recommended Operating Range (Micro-computer Chip) at $Ta = -10^{\circ}C$ to $+65^{\circ}C$, $V_{SS} = 0V$

Danamatan	O. seek ed	Pins	Conditions		V _{DD} [V]	Ratings			Unit
Parameter	Symbol	Pins				min	typ	max	Unit
Operating supply voltege	V _{DD}	CpuV _{DD}	$0.229\mu s \le t_{CYC} \le 200\mu s$			4.5		5.5	٧
Hold voltage	VHD	CpuV _{DD}	RAMs and the registers data are kept in HOLD mode.			2.0		5.5	V
High level input voltage	VIH (1)	Ports0, 1, P00 port input /interrupt			4.5 to 5.5	0.3V _{DD} +0.7		V _{DD}	V
	VIH (2)	Port00 Watch-dog timer			4.5 to 5.5	0.9V _{DD}		V _{DD}	V
	VIH (3)	RES			4.5 to 5.5	0.75V _{DD}		V_{DD}	V
Low level input voltage	VIL (1)	Ports0, 1, P00 port input /interrupt			4.5 to 5.5	V _{SS}		0.1V _{DD} +0.4	V
	VIL (2)	Port00 Watch-dog timer			4.5 to 5.5	V _{SS}		0.15V _{DD} +0.4	V
	VIL (3)	RES			4.5 to 5.5	V _{SS}		0.25V _{DD}	V
Operation cycle	t _{CYC} (1)		All functions operating		4.5 to 5.5		0.231		μS
time (*1)	t _{CYC} (2)		OSD and Data slicer are not operating		4.5 to 5.5	0.231		200	μS
Oscillation frequency range	FmVCO1		Built-in VCO1 Oscillation System clock		4.5 to 5.5		13.0		MHz
	FmVCO1		Built-in VCO2	OCKSEL = 0	4.5 to 5.5		12.5		MHz
	(*2)		oscillation OSD clock	OCKSEL = 1			16.6		MHz
	FmRC		Built-in RC oscillation		4.5 to 5.5	0.3	1.0	2.0	MHz
	FsX'tal	XT1 (P07) XT2 (P06)	At the 32.768KHz crystal Oscillating See the figure 1		4.5 to 5.5		32.768		kHz
Oscillation stabilizing time	tmsVCO		•after the HOLD mode •Power-On		4.5 to 5.5		300		mS

(Note) FLASH-ROM erase/write temperature range : Ta = $25\pm2^{\circ}$ C (V_{DD} = 4.5 to 5.5V)

^(*1) Relational expression between $t_{\mbox{CYC}}$ and oscillation frequency ;

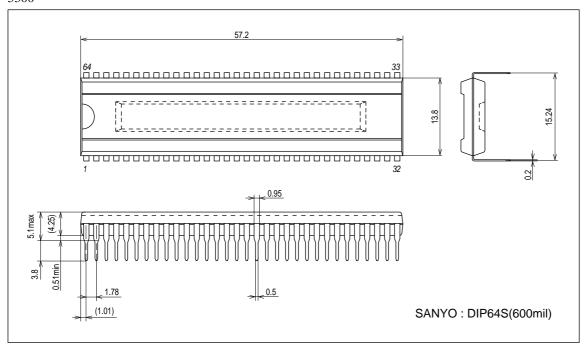
^{1/1} frequency dividing: 3/FmVCO1, 1/2 frequency dividing: 6/FVCO1.

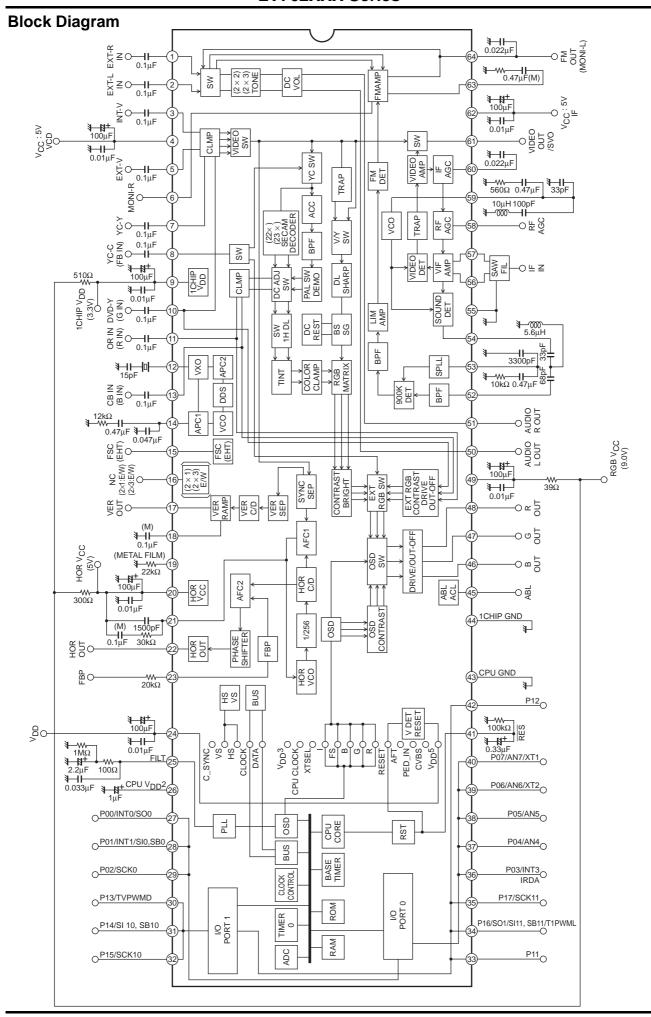
 $^{(^*2) \ \}mathsf{OCKSEL} \ \mathsf{is} \ \mathsf{the} \ \mathsf{selectable} \ \mathsf{register} \ \mathsf{for} \ \mathsf{OSD} \ \mathsf{clock} \ \mathsf{frequency}. \ (\mathsf{See} \ \mathsf{the} \ \mathsf{LC873200} \ \mathsf{users} \ \mathsf{manual} \ \mathsf{for} \ \mathsf{details}.)$

Package Dimensions

unit: mm (typ)

3300





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